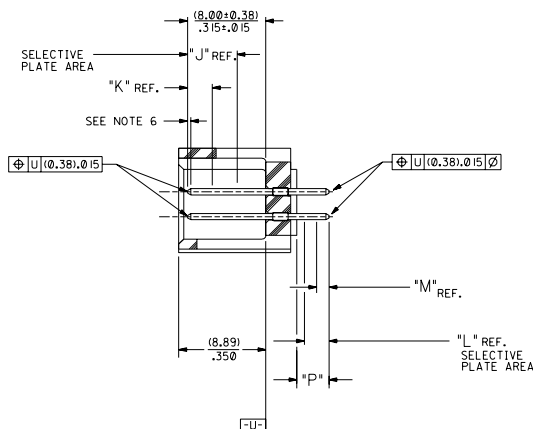


RECOMMENDED P.C. BOARD HOLE LAYOUT



SECTION J-J

NOTES:

- 1- 20 CIRCUIT SIZE SHOWN FOR ILLUSTRATION PURPOSES.
- 2- PIN PUSHOUT FORCE: (17.79 N)/4 LBS.
- 3- PINS MUST MEET SOLDERABILITY SPEC. MIL-STD-202 METHOD 208B.
- 4- WINDOW NOT AVAILABLE ON 6 AND 8 CIRCUIT SIZE.
- 5- FOR CHARTED DIMENSIONS AND ASSEMBLY NO.S NOT SHOWN ON THIS SHEET - SEE SHEET 2.
- 6- ROW TO ROW PIN HEIGHT VARIATION MUST NOT EXCEED (0.131/.005 IN.
- 7- PRODUCT CONFORMS TO PS-8723.

[illegible]

MATERIAL:

SHROUDED WAFER: GLASS FILLED POLYESTER, 94V-0; COLOR: BLACK.
PINS: PHOSPHOR BRONZE,
SEE SHEET 2 FOR FINISHES.

ASSEMBLY STYLE "A" AND "B"

DIMENSIONS SHOWN METRIC INCH						MFG. SQA.	REV.	LTR.	REVISIONS
☒ YES = 0 ☐ NO REWIND ONLY ON CAD SYSTEM									
TITLE						SALES ASSEMBLY			
WAFFER - STRAIGHT MT. FULLY SHROUDED						SO. PINS			
WITH .066 END WALLS									
MOLEX INCORPORATED						SHEET NO.	DATE		
LIT./CAL. 68532						OF 7	92-07/17		
PART NO.						CNDR.	SDA-1873		
SEE CHART						SDA-81273			
FILE NAME						THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION FROM MOLEX INC.			
DRAWING BY						DATE	DWN.		
SCALE 4 : 1									

